

CPU: SM7150/7125 SDM710/670 MSM8953/8994/8956/8974/8976/8992/8996
MT6797W/6739V/6795W/6768/6769/6595/6763V/6771V RAM256/361

Mbga-B6



Main page > Repair Equipment > Soldering Equipment > Platform reballing BGA > AMAOE Mbga-B6 BGA reballing platform with stencils for CPU

AMAOE Mbga-B6 BGA reballing platform with stencils for CPU

Product ID: 22941

Price: **57.00 EUR**

Product weight: **1.00 kg**

Description:

AMAOE Mbga-B6 BGA reballing platform with stencils for CPU- Reballing platforms are high-quality products that enable precise re-creation of balls connecting the upper and lower parts of the motherboard and for removing glue. Made of high-quality synthetic stone, resistant to high temperatures and quickly cooling down. Platforms equipped with very strong magnets that prevent movement during soldering work using templates / reballing sieves. The screen template is a product made of steel resistant to high temperatures and deformation.

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